HP ProLiant G6

Technologies for better business outcomes

RUN WITH CONFIDENCE

Franz Weberberger Product Manager ISS April 2009



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HP ProLiant Industry Standard Server

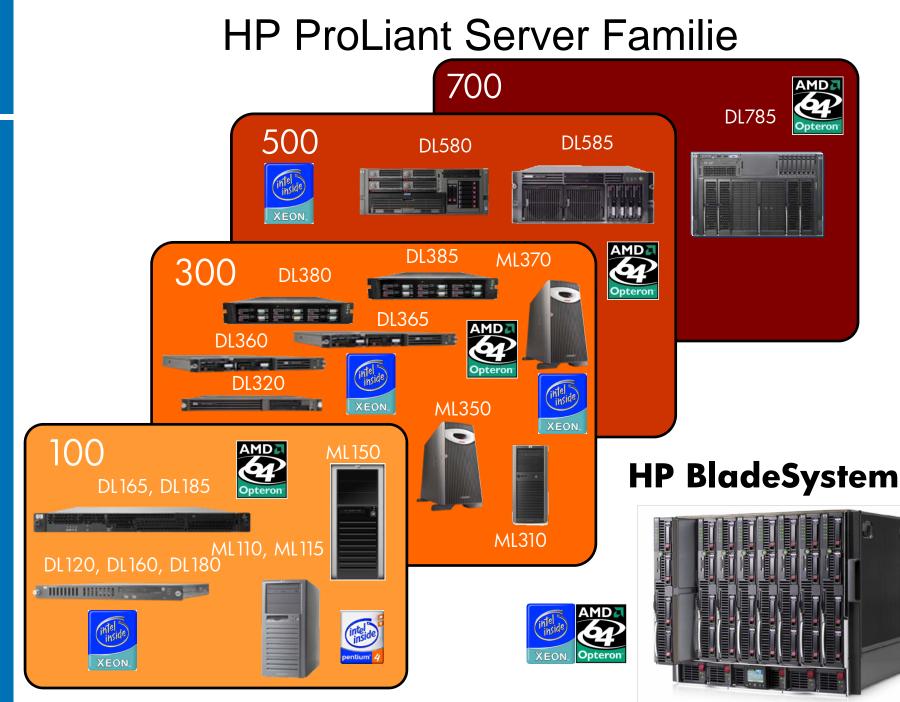


ESS – Enterprise Server & Storage



The best high-volume AND high-value solutions

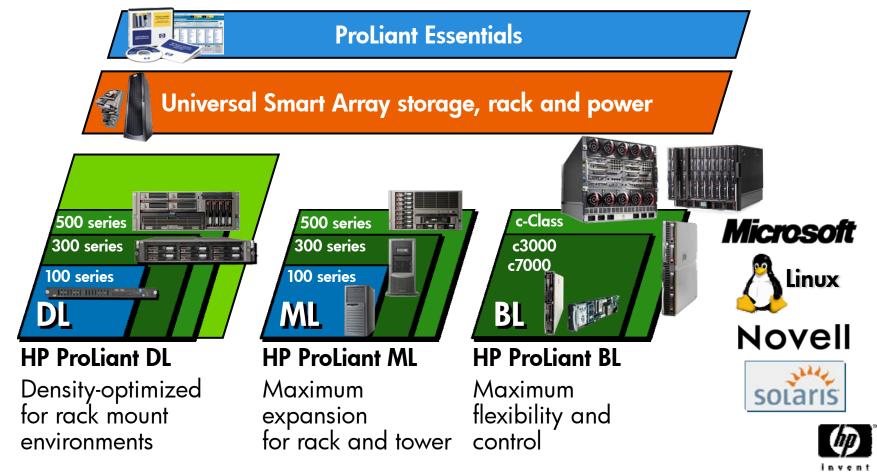




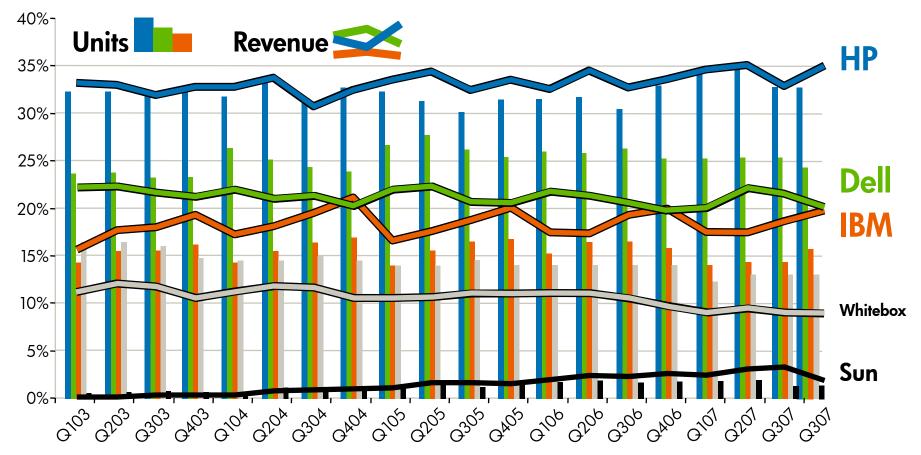
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HP ProLiant Server Linien

Industry Standard tools for an Adaptive Enterprise



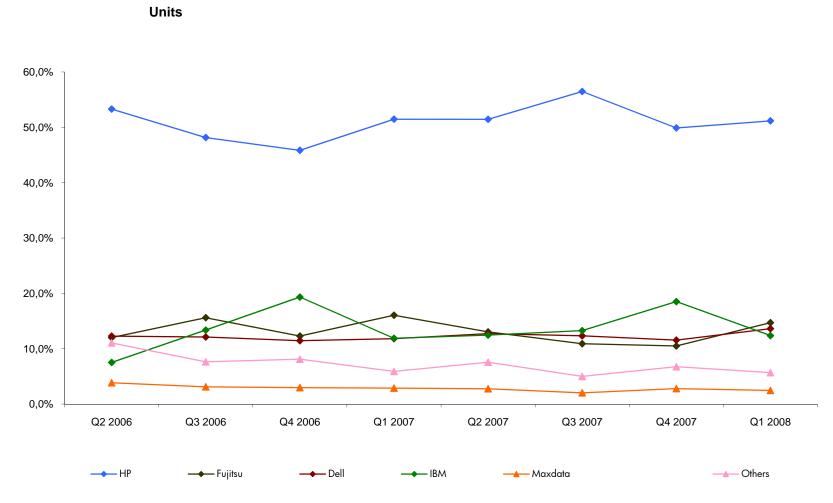
Weltweiter x86 Market share





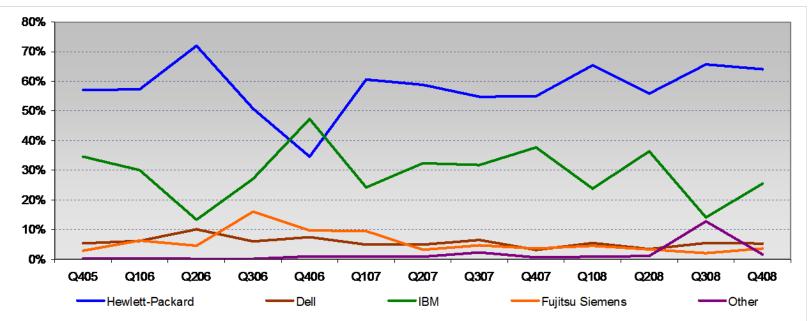
Source: IDC Worldwide Quarterly Server Tracker: 4Q07, February 26, 2008

Österreich x86 Market Share





x86 Mkt Share Evolution – Blades Units Austria

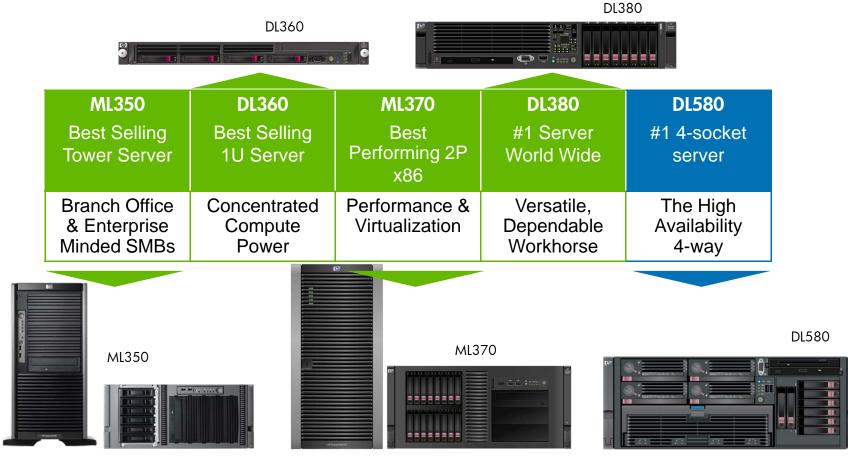


Mkt Share	Q405	Q106	Q206	Q306	Q406	Q107	Q207	Q307	Q407	Q108	Q208	Q308	Q408
Hewlett-Packard	57%	57%	72%	51%	35%	61%	59%	55%	55%	65%	56%	66%	64%
Dell	5%	6%	10%	6%	7%	5%	5%	7%	3%	5%	3%	5%	5%
IBM	35%	30%	13%	27%	47%	24%	32%	32%	38%	24%	36%	14%	25%
Fujitsu Siemens	3%	6%	5%	16%	10%	9%	3%	5%	4%	4%	3%	2%	4%
Other	0%	0%	0%	0%	1%	1%	1%	2%	1%	1%	1%	13%	2%
Unito	0.405	0106	0006	0206	0406	0107	0207	0207	0407	0400	0000	0200	0.400
Units	Q405	Q106	Q206	Q 306	Q 406	Q107	Q207	Q307	Q407	Q108	Q208	Q308	Q408
Hewlett-Packard	620	481	585	472	391	690	647	598	1,081	1,003	1,106	1,140	1,199
Hewlett-Packard Dell	620 58	481 52	585 82	472 56	391 84	690 56	647 54	598 71	1,081 61	1,003 84	1,106 68	1,140 95	1,199 99
Dell	58	52	82	56	84	56	54	71	61	84	68	95	99
Dell IBM	58 376	52 252	82 108	56 252	84 534	56 276	54 356	71 347	61 742	84 365	68 721	95 244	99 477
Dell IBM Fujitsu Siemens	58 376 31	52 252 53	82 108	56 252	84 534 110	56 276 108	54 356 35	71 347 51	61 742 71 12 1,967	84 365 69 13 1,534	68 721 65 21 1,981	95 244 35	99 477 67 30 1,872



ProLiant enterprise server line-up

Intel Xeon-based systems





HP Restricted. For HP and Channel Partner Internal Use. May be shared with select customers under CDA. HP Confidential NDA required

The HP BladeSystem Enclosure portfolio Time-Smart, Energy-Efficient, Cost-savvy

2006



Datacenter optimized

Holds 16 c-Class server blades

September 2007

Remote sites and midmarket

C3000 Tower



Rack-able or set on a table

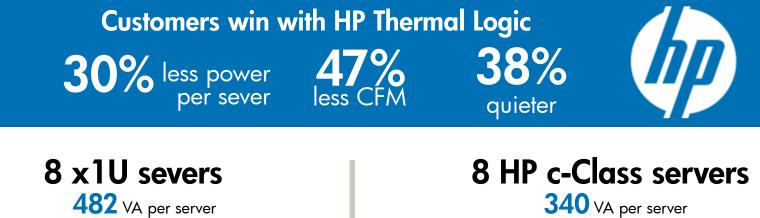


Place on a floor using the Tower version





Blades benötigen weniger Energie als normale Server!



(Intel 5140 dual-core)

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Power: 3856 VA @100% CPU Util.

Cooling: 323 CFM

Acoustics: 8.1 bels

Power: 2720 VA @100% CPU Util.

Cooling: 172 CFM

Acoustics: **7.4** bels

> Assumptions: Same load/same configuration (2 x 5140 CPU w/ 8 DIMMs each running Prime95 @100%)

340 VA per server

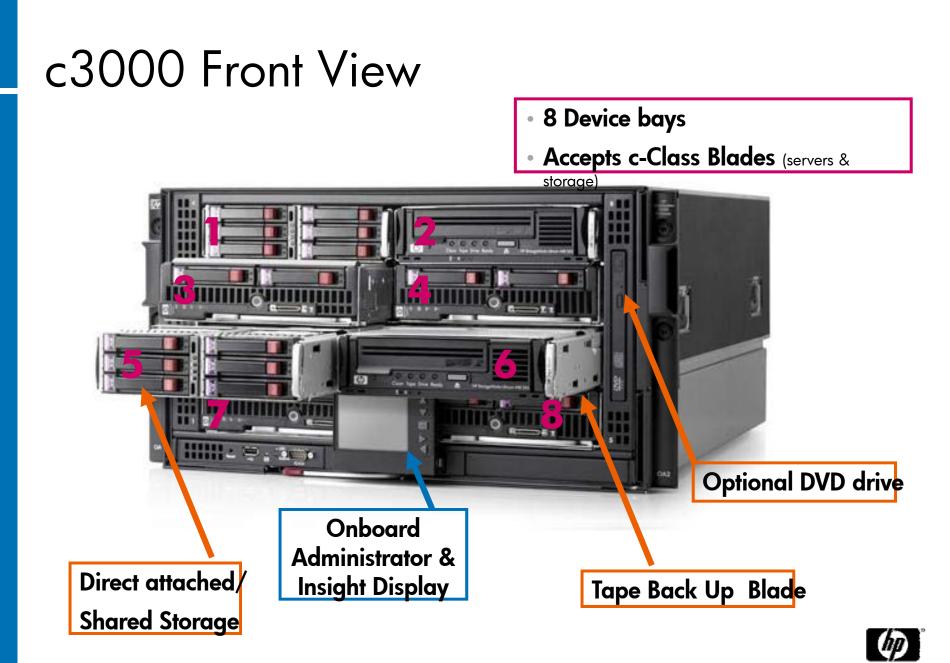
HP BL460c

(Intel 5140 dual-core)

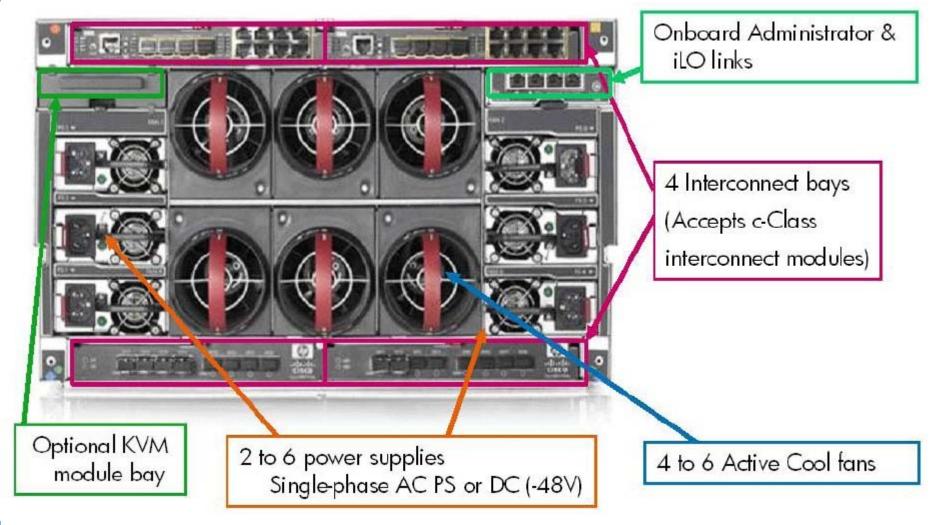


HP Confidential NDA required

CFM (Cubic feet per minute) of air (costs to run datacenter equipment for cooling are significant)



c3000 Rear View





HP BladeSystem c-Class Portfolio



A Full Range of 2P and 4P Blades



Interconnect choices for LAN, SAN, and Scale-Out Clusters



Support

HP ProLiant G6



Leading Efficiency

Increased Power Efficiency over G5

- energy
- Energy Star rated
- All power supplies are up to 92% efficient
- SpecPower Leadership

Ultimate power management



- Control your power budget
- Dynamic power capping
- Conserve energy

Right-sized Power Supplies



- Only pay for the power you need
- Fuller load resulting in greater efficiency
- Choose from 460W, 750W or 1200W power supplies



Continued Leadership in Energy Efficiency

- Dynamic Power Capping
- Intelligent Power & Cooling Savers
 - o Sea of Sensors
 - Power Down Mode Support on DDR-3
 - \circ $\;$ Dynamic Power Management of unused i/o ports.
 - Individual Fan Management for Dynamic cooling and power management.
- Intel Nehalem performance with lower power envelopes.



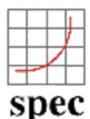


Power delivery

Pówer/Cooling

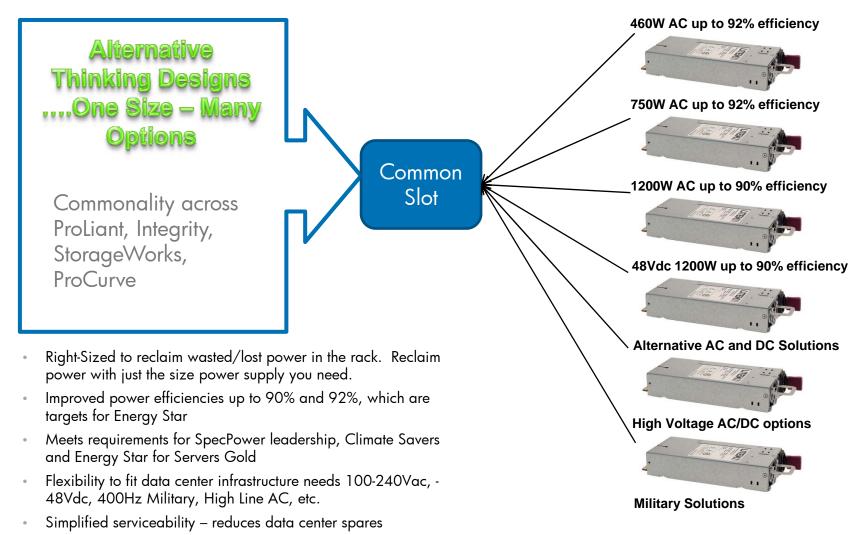
efficiency

- HP Common Power Slot- one power source fits many platforms reduced spares
- Higher Efficiency Power Supplies, up to 92% to meet Energy Star and Climate Savers Gold requirements.
- Right-Sizing for the perfect power fit improved capacity
- High Efficiency and Load Balancing Modes for Redundant Power Supplies.





G6 Common Slot Power Strategy





Extreme Flexibility

Flexible storage

- More servers with choice of LFF or SFF drives
- Choice of SSD support

Common power slot

Reduces # of spares needed

Simplifies Ordering





Flexible Smart Array Portfolio

 Mix and match cache with batteries for performance and availability

Flexible I/O

- More Slots / More I/O choice (PCI-E x8,x16 and PCI-X)
- More 10GbE options



ProLiant G6:Technology Prozessor



Nehalem Processor

Higher performance, better power efficiency, more adaptable

QuickPath Architecture

Delivers additional performance, bandwidth, and reliability

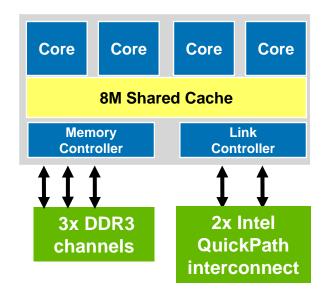
Integrated Memory Controller Each processor now has a dedicated memory controller

Turbo Mode

Additional processing boost during peak demand periods

Dynamic Power Management

Hyper-Threading Technology Enhances performance and energy efficiency

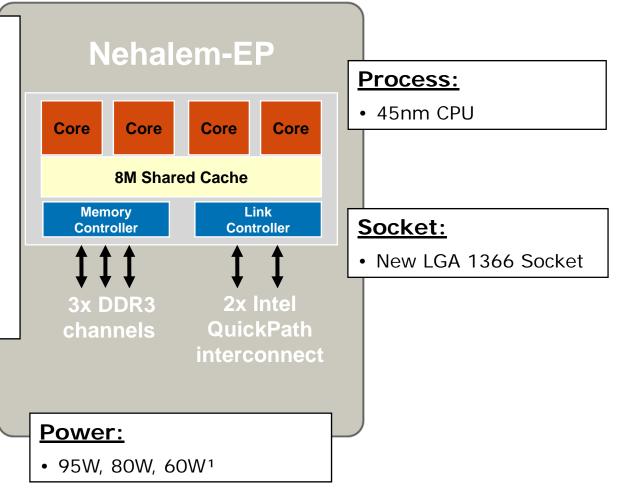




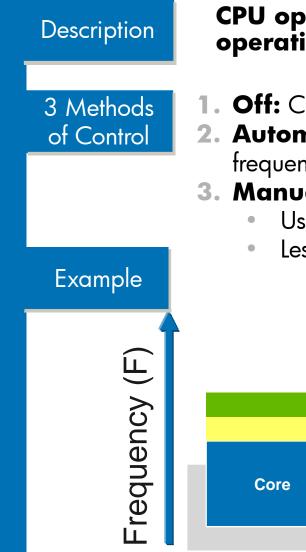
Intel Nehalem Processor Details

Features:

- 2 or 4 cores
- 8M on-chip Shared Cache
- Simultaneous Multi-Threading capability (SMT)
- Intel[®] QuickPath Interconnect up to 6.4 GT/s, each direct. per link
- Integrated Memory Controller (DDR3)
- New instructions

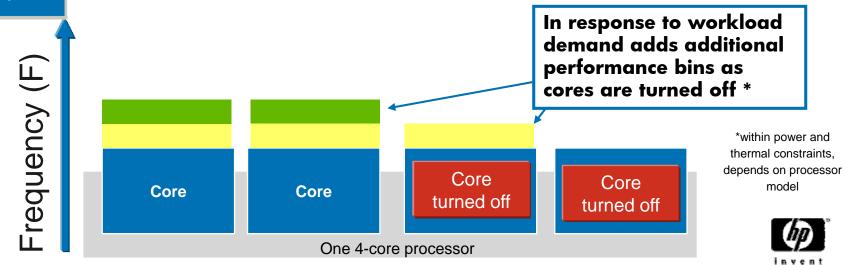


Nehalem Turbo Mode

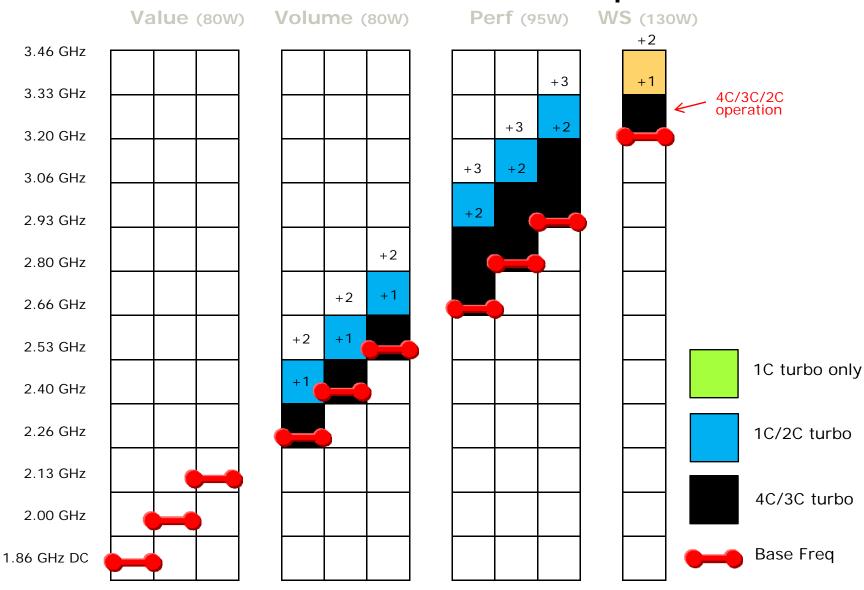


CPU operates at higher-than-stated frequency when operating below power and thermal design points

- **1. Off:** CPU operates only at rated frequency
- 2. Automatic: OS requests higher perf state, CPU determines turbo frequency (recommended)
- 3. Manual:
 - User can manually disable cores (reboot required) via BIOS
 - Less cores means more likely turbo will happen



Nehalem-EP Turbo Mode Frequencies





ProLiant G6:Technology Memory



New DDR-3 Memory Benefits

Bandwidth doubles

- •DDR-2; 667MHz 4 channels
- •DDR-3; 1333MHz 6 channels

Flexibility

• Unbuffered DIMMs

• Registered DIMMs

Lower latency

•24GB/sec with DDR-2

•64GB/sec with DDR-3

25% power savings over DDR2

•Voltage reduced from 1.8V to 1.5V

•Thermal temperature sensors allow power down when idle

Larger memory footprints

- Increased slot counts with G6
- Max Memory up to 24GB with U-DIMMs
- Max Memory up to 144GB with R-DIMMs



Customer choice with DDR-3

	Memory Technology Compari	son
	RDIMMs Greater capacity, ECC w/advanced memory protection	UDIMMs Smaller capacity, lower price points, ECC
Capacities at launch	2GB, 4GB, 8GB	1GB, 2GB
Max. DIMMs/Channel	3 Dual Rank	2 Dual Rank
Advanced Memory Protection		
ECC support	\checkmark	\checkmark
Lower Cost		\checkmark
Ranks/DIMM support	1, 2, 4	1, 2
DRAM support	x4, x8	x8
Maximum capacity	144GB max capacity (18 slots, dual rank)	24GB max capacity (12 slots)



Note: No Mixing of RDIMM and UDIMM

DDR3 memory capacities

- RDIMM maximum capacity 144GB (8GB 2Rank)
- UDIMM maximum capacity 24GB (2GB 2Rank)

DIMM Type ->	RDIMM	UDIMM	UDIMM	UDIMM	UDIMM	UDIMM	UDIMM								
DIMM Rank ->	1R	1R	1R	2R	2R	2R	4R	4R	4R	1R	1R	2R	2R	4R	4R
DIMM Capacity ->	2GB	4GB	8GB	2GB	4GB	8GB	2GB	4GB	8GB	1GB	2GB	1GB	2GB	1GB	2GB
	200	400	000	200	400	000	200	400	000	100	200	100	200	100	200
SLOTS THAT CAN BE POPULATED															
9 slot servers	n/a	n/a	n/a	9	9	9	n/a	6	6	6	n/a	n/a	6	n/a	n/a
12 slot servers	n/a	n/a	n/a	12	12	12	n/a	12	12	12	n/a	n/a	12	n/a	n/a
16 slot servers	n/a	n/a	n/a	16	16	16	n/a	12	12	12	n/a	n/a	12	n/a	n/a
18 slot servers	n/a	n/a	n/a	18	18	18	n/a	12	12	12	n/a	n/a	12	n/a	n/a
MAXIMUM CAPACITY															
9 slot servers	n/a	n/a	n/a	18	36	72	n/a	24	48	6	n/a	n/a	12	n/a	n/a
12 slot servers	n/a	n/a	n/a	24	48	96	n/a	48	96	12	n/a	n/a	24	n/a	n/a
16 slot servers	n/a	n/a	n/a	32	64	128	n/a	48	96	12	n/a	n/a	24	n/a	n/a
18 slot servers	n/a	n/a	n/a	36	72	144	n/a	48	96	12	n/a	n/a	24	n/a	n/a
POPULATED DIMM SPEED (MHz)															
1 DIMM Per Channel	n/a	n/a	n/a	1333	1333	1067	n/a	1067	1067	1333	n/a	n/a	1333	n/a	n/a
2 DIMM Per Channel	n/a	n/a	n/a	1067	1067	1067	n/a	800	800	1067	n/a	n/a	1067	n/a	n/a
3 DIMM Per Channel	n/a	n/a	n/a	800	800	800	n/a								

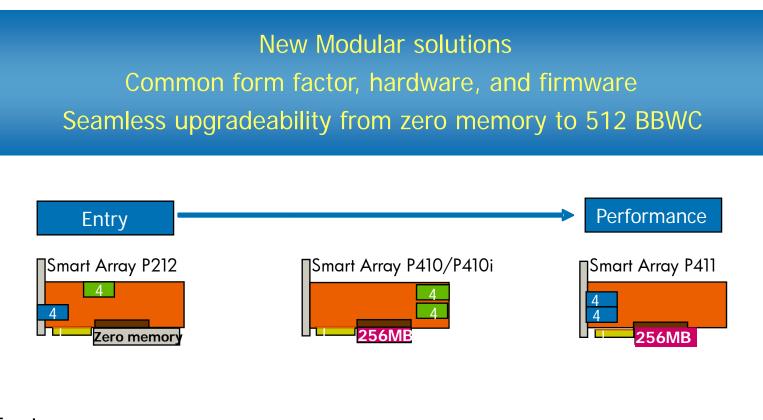
95 Watt processors needed to run 1333MHz. See population rules for additional guidelines.



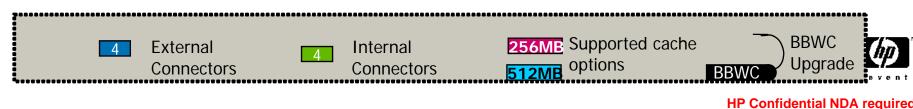
ProLiant G6:Technology Smart Array & Hard Drives



New Modular Smart Array Controller Configurations



Features



HP SAS Expander Card

Ports Available

- Support 24 drive bays plus external
- Internal/External Split
 - 8 internal ports used for Smart Array connection
 - One Mini SAS 8i internal connector
 - 24 internal ports used for HDD/tape connection
 - Three Mini-SAS 8i internal connectors
 - 4 external ports for tape
 - One Mini-SAS 4x external connector

Support

- 3.0 Gbps SAS and 1.5 Gbps SATA
 - FW upgrade to 6 Gbps SAS and 3 Gbps SATA in Summer 09
- PCIe full-height card just using PCIe power

Support Continued

- Internal and External Devices
 - SAS/SATA HDD (internal only)
 - Tape Drives (internal and external)
 - DAT 160 SAS
 - LTO448
 - LTO920
 - LTO 1840
 - Servers
 - ML350 G6
 - ML370 G6
 - DL380 G6
 - DL385 G5p
 - DL385 G6
 - DL580 G5
 - DL785 G5
 - DL785 G5p
- Controllers
 - P410 with cache
 - P410i with cache



Smart Array Advanced Pack (SAAP) – January 2009

What is SAAP?

SAAP is a paradigm shift in how features are received and utilized by the introduction of "silver bullet" features to continue driving SAS, Smart Array value and differentiation .

Customer Values

Control over environment

Tunable stacks/Flexibility

Deployment methodology



- RAID 6 (ADG)
- RAID 60
- Advanced Capacity Expansion (ACE)
- Split Mirrors and Recombining of them in offline mode
- Secure Drive Erase
- Performance Optimization Degraded Reads and Read Coalescing (VOD)



ProLiant G6:Technology Nics



New Embedded NICs on ProLiant G6 Servers

G6 Platform	Networking Controller	HP Model	What's New	
DL160 DL180	Intel 82576	HP NC362i	Dual port, high- performance gigabit connectivity designed for a multi-core and virtualized platform	
DL360 DL380	Broadcom 5709	HP NC382i	Latest multifunction NIC supporting TCP/IP offload and iSCSI iSCSI IS NOW INCLUDED FREE – NO LICENSE REQUIRED Four ports on DL380 G6	
DL/ML370	NetXen 3031	HP NC375i	Four 1GbE ports TWO EMBEDDED NIC PORTS CAN BE UPGRADED TO 10GbE	
DL320 ML330 ML350	Broadcom 5715	HP NC326i	Dual port performance designed to support reliability, flexibility, and expandability	
ML150	Broadcom 5723	HP NC107i	Single port Gigabit performance for cost- effective, entry-level platforms	





ProLiant G6:Technology Onboard Administrator powered by iLo2



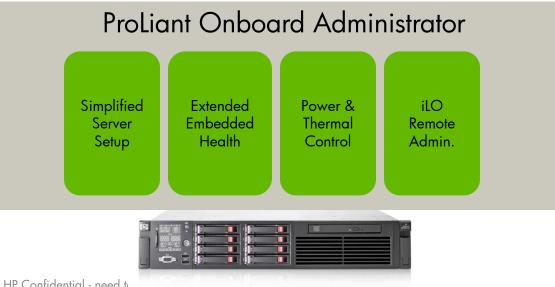
ProLiant Onboard Administrator The core of ProLiant manageability

Enable hands off deployment for one server or hundreds

Investigate server health in any situation from any location



Save hundreds or thousands in travel cost and downtime





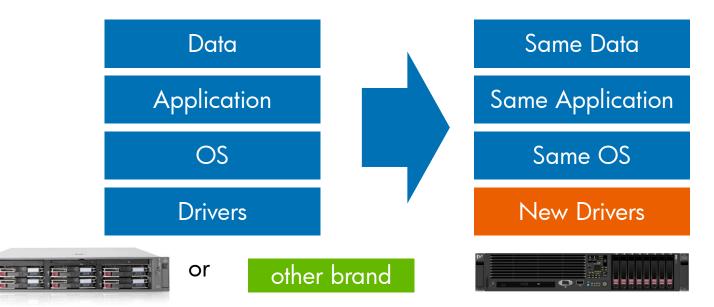
HP Integrated Lights-Out iLO 2

• iLO 2 help you manage your ProLiant G6 agentlessly

- Status, presence, redundancy
- Fan, temperature, power supplies, VRM
- Hard Drive presence
- Server status
- ProLiant F6 Fan Control and DIMM Temperature metrics
- iLO 2 can help you manage your ProLiant G6 server power consumption
 - Receive data from ProLiant G6 servers to calculate the hottest core temperature
 - Gain access to server registers
 - Decrease system power consumption when a temperature threshold is breached
- And much more!
 - Logging memory issues, power throttling, etc...

Simply migrate your existing server to G6 No need for from-the-ground-up deployment

Server Migration Pack Universal Edition



Automated migration process takes care of driver compatibility Drop or resize partitions during migration

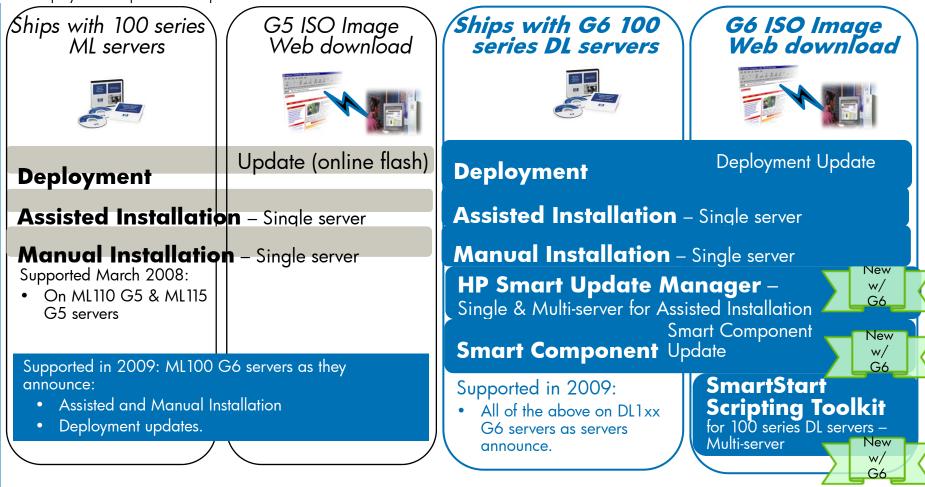
Confidently upgrade, Accelerate deployment Minimize cost of transition



2009

HP ProLiant Easy Set-up CDs -New Features for 100 series G6 servers

Deployment & Update CD - 1 per model



ProLiant 100 series G6 servers get this capability as each server announces. Ships as part of server BOM.

Blue = new w/ProLiant 100 series G6



ProLiant 300 series G6 Product Details



HP ProLiant DL360



	DL360 G5	DL360 G6
Processor	Intel Xeon 5000 Sequence	Intel Nehalem - EP
Memory	8 Sockets, DDR2 667MHz 64GB max.	18 Sockets, DDR3 800Mhz to 1333MHz 144GB max.
Drive Bays	6 SFF SAS/SATA	8 SFF SAS/SATA
Storage Controller	P400i/E200i	P410i
Slots	<u>2 Available Slots</u> -1full length x16 PCI-e /-1 low profile PCI-e x8 -1 optional PCI-x 133 replace full length PCI-	<u>2 Available Slots</u> -1full length x16 PCI-e Gen2/ -1 low profile x8 PCI-e Gen2 -1 optional PCI-x 133 replace full length PCI-e
Networking	2 NIC ports [NC373i Multifunction (Broadcom)	2 NIC ports, NC382i
Ports	Front: USB (1), video Rear: USB (2), Video, NIC / Internal: USB (1)	Front: USB (1), video Rear: USB (2), Video, NIC / Internal: USB (1)/ SD slot (1)
Management	ILO 2	Onboard Administrator w/ ILO 2
Security		TPM option
Redundancy	Fan: N+1 Power:1	Fan: N+1 Power:1

invent

HP ProLiant DL380



	DL380 G5	DL380 G6
Processor	Intel Xeon 5000 Sequence	Intel Nehalem - EP
Memory	8 Sockets, DDR2 667MHz 64GB max.	18 Sockets, DDR3 800Mhz to 1333MHz 144GB max.
Drive Bays	8 SFF SAS/SATA	Up to 16 SFF SAS/SATA or 6 LFF SAS/SATA (Different drive cages for SFF and LFF)
Storage Controller	P400/E200	P410i
Slots	PCI-E Gen 1: Embedded: 2X4 PCI-E Standard Riser: 1X4 and 2 X8 PCI-E Optional Riser: PCI-X/PCI-E (2 PCI-X, 1X8 PCI-E) (Max. PCI-E slots: 4)	PCI-E Gen 2: Standard Riser: 1X8 and 2 X4 PCI-E Optional Risers: X16 PCI-E; PCI-X/PCI-E (2 PCI-X/133, 1X8, 1 X4 PCI-E (Max. PCI-E slots: 6)
Networking	2 NIC ports,NC373i	4 NIC ports, NC382i
Ports	Front: USB (2), video Rear: USB (2), Video, NIC Internal: USB (1)	Front: USB (2), video Rear: USB (2), Video, NIC Internal: USB (1)/ SD slot (1)
Management	ILO 2	Onboard Administrator w/ ILO 2
Security		TPM option
Redundancy	Fans: Hot plug with optional redundancy Power: 1	Fans: Hot plug with optional redundancy Power: 1



HP ProLiant ML350



	ML350 G5	ML350 G6
Processor	Intel Xeon 5000 Sequence	Intel Nehalem - EP
Memory	8 Sockets, DDR2 667MHz 32GB max.	18 Sockets, DDR3 800Mhz to 1333MHz 144GB max.
Drive Bays	8 SFF or 6 LFF SAS/SATA	Up to 16 SFF SAS/SATA or 8 LFF SAS/SATA (Different drive cages for SFF and LFF) 5 removable half height media bay
Storage Controller	P400/E200	P410i
Slots	PCI-E 5 Available slots 3 full-length PCIe x8 (x4 speed) Gen 1 1 64bit PCI-X (1-133MHz, 2-100MHz) Option for 2 PCI-X slots replacing a PCIe slot	PCI-E Gen 2 8 Available slots 1 full-length PCIe x16 (x8 speed) Gen2 1 full-length PCIe x8 Gen2 4 full-length PCIe x8 (x4 speed) Gen2 1 full-length PCIe x8 (x4 speed) Gen1 Option for 2 PCI-X slots replacing a PCIe slot (similar to G5)
Networking	1 NIC port, NC373i	2 NIC ports, NC326i
Ports	Front: USB (2) Rear: USB (2), Video, NIC Internal: USB (1)	Front: USB (2) Rear: USB (2), Video, NIC (2) Internal: USB (2), SD slot (1)
Management	ILO 2	Onboard Administrator w/ ILO 2
Security		TPM option

HP Confidential NDA required

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HP ProLiant DL370 and ML370



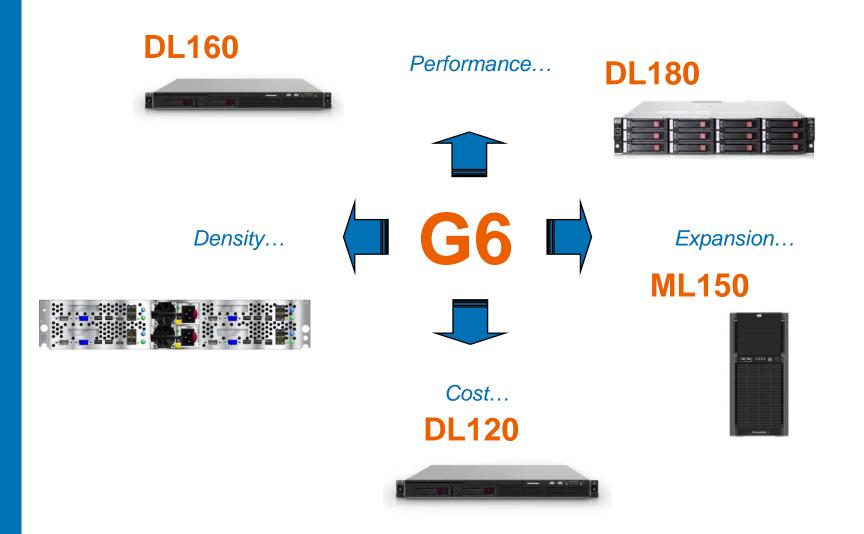
	ML370 G5	DL370 and ML370 G6
Processor	Intel Xeon 5000 Sequence	Intel Nehalem - EP
Memory	16Sockets; DDR2 667MHz 64GB	18 Sockets, DDR3 800Mhz to 1333MHz 144GB max.
Drive Bays	8 SFF hot plug SAS or SATA standard 16 SFF Hot plug SAS or SATA optional 2 Media Bays (2 half height) standard	Up to 24 SFF hot plug SAS or SATA standard; or 14 LFF 3 Media Bays (2 half height, 1 slim line) standard
Storage Controller	P400/E200	P410i
Slots	PCI-e Gen 1 9 slots 8 available: (6) PCI-E x4 (2) PCI-X 64-Bit/133MHz	PCI-e Gen 2 9 slots (2x16, 2x8, 5x4) Accelerators 300 watt in x16 slots 2 PCI-x slots optional (replacing PCI-e slots)
Networking	2 NIC ports, NC373i	4 NIC ports, NetXen (w/10G optional upgrade card)
Ports	Front: USB (2), video / Rear: USN (2), Video, NIC Internal: USB (2)	Front: USB (2), video / Rear: USN (2), Video, NIC Internal: USB (2)/ SD slot (1)
Management	ILO 2	Onboard Administrator w/ ILO 2
Security		TPM option
Redundancy	Fan: RPS:	Fan: RPS:
Form Factor	5U	40



ProLiant 100 series G6 Product Details



HP ProLiant 100 series





HP ProLiant DL160



High performance, highly efficient compute for scale-out environments

	DL160 G5	DL160 G6
Processor	(2) Xeon (Harpertown/Wolfdale)	(2) Xeon (Nehalem EP)
Memory	8 Sockets, DDR2 667-800MHz FBD	18 Sockets, DDR3 1067/1333
Drive Bays	4 LFF SATA/SAS NHP/HP	Up to 4 LFF or 8 SFF SATA/SAS NHP/HP
Storage Controller	SW RAID embedded with NHP models; SAS HBA with HP models; Smart Array optional	HP SW RAID embedded with NHP skus; Smart Array P212 with HP skus; Smart Array P4xx, P8xx optional
Slots	2 Available slots 1 full-length PCI-E gen 2 x 16 gen 2 1 half length low-profile PCI-E gen 2 x 16 2 optional PCI-X 133 replaces full-length PCI-E and 1 PCI-X 133 low profile	2 Available slots 1 full-height/full length PCI-E x16 Gen2 OR 1 internal only LP card with PCI-E x8 Gen2 and 1 HL/FH PCI-E x16 Gen2 2 optional PCI-X 133 replaces full-length PCI-E and 1 PCI-X 133 low profile
Networking	Dual-port gigabit NIC (2 NC7782)	2 Gigabit NICs
Ports	USB: 2 front, 1 internal, 2 rear Video, Serial, PS/2	USB: 2 front, 1 internal, 2 rear Video, Serial, PS/2
Security		TPM option
Management	LO 100i	LO100i; System setup and update, SNMP health agents, SIM support (Polaris & Lighthouse)



HP ProLiant DL180

High capacity, highly efficient compute for scale-out environments



	DL180 G5	DL180 G6
Processor	Xeon Quad/Dual Core	2P Xeon (Nehalem EP)
Memory	6 Sockets, DDR2 667 FBD	12 Sockets , DDR3 1067/1333
Drive Bays	4/8/12 LFF SATA/SAS	4/8/12/ 14 LFF SATA/SAS (4/8/12 standard +2 rear upgrade)
Storage Controller	SATA RAID embedded with entry models; SA E200 or P400 on other models;	HP SATA RAID with entry models (ICH-9); P212 and P410 on other models
Slots	<u>3 Available slots</u> 2 full-length PCI-e x4 1 low-profile PCI-e x8 2 optional PCI-X 133 replaces full-length PCI-E slots	<u>3 Available slots</u> 2 full-length PCI-E x8 Gen 2 1 low-profile PCI-E x16 Gen 2 2 optional PCI-X 133 replaces full-length PCI-E OR 1 optional PCI-E x16 Gen 2
Networking	1 Gigabit NIC	2 Gigabit NICs
Ports	USB: 2 front, 1 internal, 2 rear Video, Serial, PS/2	USB: 2 front, 1 internal, 2 rear Video, Serial, PS/2
Management	LO 100	LO100; System setup and update, health agents, SIM support (Polaris & Lighthouse)
Security		TPM option
Redundancy	HP RPS	HP RPS



HP ProLiant ML150



	ML150 G5	ML150 G6
Processor	Intel Xeon 5000 Sequence Intel Nehalem - EP	
Memory	6 Sockets, [RB] 16GB max.	12 Sockets, DDR3 48 GB max (24GB at launch)
Drive Bays	[4] [LFF] SAS/SATA+ optional 2nd cage for 4[4] [LFF] SAS/SATA+ optional 2nd cage for 4additional drivesadditional drives	
Storage Controller	Embedded SATA RAID 0/1 Optional SC40Ge/SC44Ge/8 Port SAS HBA	Embedded SATA RAID 0/1 Optional SA controllers
Slots	<u>6 Available Slots</u> 5 PCI-e Gen 1 1 PCI 33/32 3.3V	5 Available Slots 1 PCle x8 Gen1 2 PCle x8 Gen2 1 PCle x16 Gen2 1 32b/33MHz PCI 3.3V
Networking	Broadcom 5722	Broadcom 5723
Ports	Front: USB (2), Rear: USB (4), Internal: USB (1); 1 Serial, 1 VGA, 1 LAN	Front: USB (2), Rear: USB (4), keyboard, mouse,Video, 1 Serial, 1 Dedicated Management port, 1 GbE Port Internal: USB (2), tape, drive
Management	LO100c	LO100c
Security		TPM option



HP ProLiant G6 Blade Systems



ProLiant Generation Features

	Intel: Front Side Bus architecture; Fully- Buffered (FB) DDR2 DIMMs AMD: NUMA; RDDR-2 DIMMs		Intel : Nahalem processors; NUMA; DDR3 memory AMD: Shanghai, Istanbul processors
	Low Power DIMM options		Low Power DIMM options
	Interceptor-based Smart Array controllers		PMC-based Smart Array controllers; SA Advanced Pack
G5	2.5" SAS, SATA HDDs	G6	2.5" SAS, SATA, SSD HDDs
	Integrated 1Gb Ethernet		Integrated 10Gb Ethernet; Flex-10 in some cases
	PCI Express 1.0		PCI Express 2.0
	Internal USB ports		Internal USB ports & SD card slots
	iLO-2		iLO-2
			TPM; Rack: Common power supplies

General guidance only; some features may not be available in some products

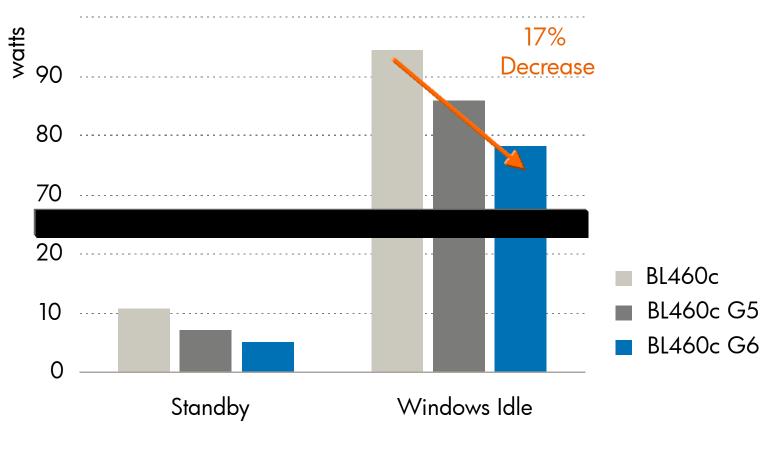


HP Confidential – HP Internal Use Only HP Confidential NDA required

HP ProLiant BL460c G6

	BL460c G6
Processor	 Up to two Dual- or Quad-Core Intel[®] Xeon[®] processor 5500 series (Nehalem-EP)
Memory	 12 DIMM Sockets Registered or Unbuffered DDR3 DIMMs, up to DDR3-1333 96 GB max
Internal Storage	 2 SFF hot-plug drive bays for SAS or SATA HDDs Smart Array P410i RAID controller with optional cache & BBWC; RAID 0/1 support Direct-Attached and Shared Storage connect options
Networking	 Embedded dual-port Flex-10 10GbE Multifunction server adapter
Mezzanine Slots	 2 mezzanine slots x8 PCIe Type-1 Mezzanine expansion slot x8 PCIe Type-2 Mezzanine expansion slot
Additional Features	 Internal USB 2.0 connector Internal SD Card slot TPM support
Management	 Integrated Lights Out 2 Standard Blade Edition Power Meter, Power Regulator, Power Capping
Density	 16 server blades in 10U enclosure 8 server blades in 6U enclosure III IIIEIIIOI OSE OIIIY HP Confidential NDA required

BL460c Improved Power Efficiency



BL460c and BL460c G5: 1P Xeon E5450 (3.0GHz, 80W), 2 x 1GB FBDIMM, 1 x 72GB SAS BL460c G6: 1P Nahalem (2.8GHz, 95W), 2 x 1GB DDR3-1333 UDIMMs, 1 x 72GB SAS



HP Confidential – HP Internal Use Only HP Confidential NDA required

HP ProLiant BL490c G6



	BL490c G6
Processor	• Up to two Quad-Core Intel® Xeon® processor 5500 series (Nehalem-EP)
Memory	 18 DIMM Sockets DDR3 Registered or Unbuffered DDR3 DIMMs, up to DDR3-1333 144 GB max
Internal Storage	 2 SFF non hot-plug drive bays (SSD only) HP Embedded SATA Controller Direct-Attached and Shared Storage connect options
Networking	• Embedded dual-port Flex-10 10GbE Multifunction server adapter
Mezzanine Slots	 2 mezzanine slots x8 PCIe Type-1 Mezzanine expansion slot x8 PCIe Type-2 Mezzanine expansion slot
Additional Features	 Internal USB 2.0 connector Internal SD Card slot TPM support
Management	iLO-2 Standard Blade EditionPower Meter, Power Regulator, Power Capping
Density	 16 server blades in 10U enclosure 8 server blades in 6U enclosure
Confidential – HP	Internal Use Only HP Confidential NDA required

HP ProLiant BL685c Ge





HP Confidential	– NDA	Required
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8L685c G	
Processor	
Memory	
Internal Storage	
Networking	server adapters
Mezzanine Slots	3 PCle x8 mezzanine expansion slots
Additional Features	 Internal USB 2.0 connector Internal SD Card slot TPM support
Management	iLO-2 Standard Blade EditionPower Meter, Power Regulator, Power Capping
Density	 8 server blades in 10U enclosure 4 server blades in 6U enclosure
	HP Confidential NDA required

Transition G5 -> G6





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Transition Roadmap

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